

# har-modular F4 module female straight



Part number	02 52 904 1201
Specification	har-modular F4 module female straight
HARTING eCatalogue	https://b2b.harting.com/02529041201

Image is for illustration purposes only. Please refer to product description.

### Identification Connectors Category Series har-modular<sup>®</sup> Identification F4 module Element Female connector Description of the contact Straight Version Width of the module 10.16 mm Reflow soldering termination (THR) Termination method Wave soldering termination Motherboard to daughtercard Connection type Mezzanine Number of contacts 4 Contact configuration Rows a and c, positions 1 and 3 Termination length 4.5 mm **Technical characteristics** Contact spacing (mating side) 5.08 mm Rated current 6 A 3 mm in the module Clearance distance 1.6 mm to module edge 3 mm in the module Creepage distance 1.6 mm to module edge >10<sup>11</sup> Ω Insulation resistance

Page 1 / 4 | Creation date 2021-12-18 | Please note that the data specified here were taken as extracts from the online catalogue. Please refer to the user documentation for the complete and up-to-date information and data. Please also note that the user is responsible for validating functionality, conformity with applicable laws and directives, as well as for the electrical safety in the particular application. HARTING Electronics GmbH | Marienwerderstraße 3 | 32339 Espelkamp | Germany Phone +49 5772 47-97200 | electronics@HARTING.com | www.HARTING.com



## Technical characteristics

Contact resistance	≤15 mΩ
Limiting temperature	-55 +125 °C (during reflow soldering max. +240 °C for 15 s)
Insertion and withdrawal force	≤5 N
Performance level	1 acc. to IEC 60603-2
Mating cycles	≥500
Test voltage U <sub>r.m.s.</sub>	1.55 kV
Isolation group	I (600 ≤ CTI)
Hot plugging	No
Moisture Sensitivity Level (MSL)	1 acc. to ECA/IPC/JEDEC J-STD-020D

## Material properties

Material (insert)	Polyamide (PA)
Colour (insert)	Black
Material (contacts)	Copper alloy
Surface (contacts)	Noble metal over Ni Mating side Sn over Ni Termination side
Material flammability class acc. to UL 94	V-0
RoHS	compliant
ELV status	compliant
China RoHS	e
REACH Annex XVII substances	No
REACH ANNEX XIV substances	No
REACH SVHC substances	No
California Proposition 65 substances	No

## Specifications and approvals

UL / CSA	UL 1977 ECBT2.E102079 CSA-C22.2 No. 182.3 ECBT8.E102079
Railway classification	F1/I2 acc. to NFF 16-101/102
Commercial data	
Packaging size	20
Net weight	2.37 g
Country of origin	Romania

Page 2 / 4 | Creation date 2021-12-18 | Please note that the data specified here were taken as extracts from the online catalogue. Please refer to the user documentation for the complete and up-to-date information and data. Please also note that the user is responsible for validating functionality, conformity with applicable laws and directives, as well as for the electrical safety in the particular application. HARTING Electronics GmbH | Marienwerderstraße 3 | 32339 Espelkamp | Germany Phone +49 5772 47-97200 | electronics@HARTING.com | www.HARTING.com



## Commercial data

#### European customs tariff number

eCl@ss

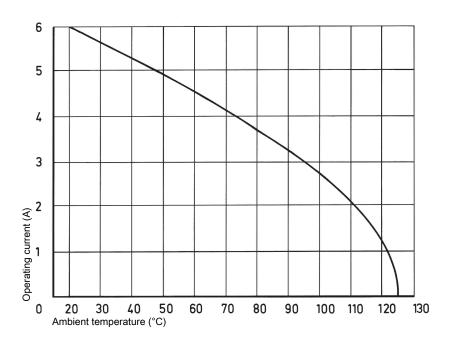
## 85366990

27460201 PCB connector (board connector)

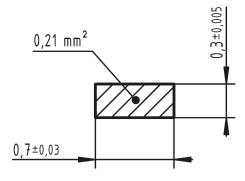
#### Current carrying capacity

The current carrying capacity of the connectors is limited by the thermal load capability of the contact element material including the connections and the insulating parts. The derating curve is therefore valid for currents which flow constantly (nonintermittent) through each contact element of the connector evenly, without exceeding the allowed maximum temperature.

Measuring and testing techniques acc. to IEC 60512-5-2



#### Cross section of solder termination



Quantity of solder paste

Before the components are assembled, solder paste must be applied to all the solder pads (for connecting surfacemount components) and the plated through holes. To ensure that the plated through holes are completely filled, significantly more solder paste must be applied than traditional solder pads on the pcb surface. There are numerous calculation methods available which are complicated to apply. The following rule of thumb has proved valuable in practice.

Required volume of paste = 2 (Volume of plated through hole - Volume of the connector termination in the hole) Comment: the multiplier "2" compensates for solder paste shrinkage during soldering. For this purpose, it was assumed that 50% of the paste consists of the actual solder, the other 50% being soldering aids.

Page 3 / 4 | Creation date 2021-12-18 | Please note that the data specified here were taken as extracts from the online catalogue. Please refer to the user documentation for the complete and up-to-date information and data. Please also note that the user is responsible for validating functionality, conformity with applicable laws and directives, as well as for the electrical safety in the particular application. HARTING Electronics GmbH | Marienwerderstraße 3 | 32339 Espelkamp | Germany

Phone +49 5772 47-97200 | electronics@HARTING.com | www.HARTING.com



Soldering instructions

THR (ThroughHoleReflow) connectors are designed to be used in a reflow oven together with other SMD (SurfaceMountDevice) components. In the process, called as well "Pin in Hole Intrusive Reflow", the connectors are inserted into plated through holes in a comparable way to conventional component mounting. All other components can be assembled on the pcb surface.

The length of the connector contacts should be such that they protrude by no more than 1.5 millimetres after insertion to the pcb. Each contact collects solder on its tip as it penetrates the solder paster in the hole. So if the contact is too long, this solder would no longer be able to reflow back into the plated through hole by capillary action during the soldering process, therefore the quality of the soldered connection would suffer as a result.

Soldering instructions

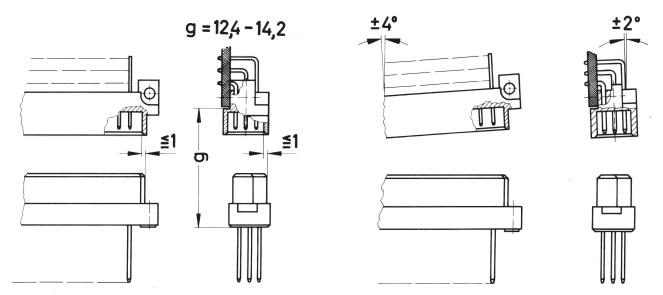
The connectors should be protected when being soldered. Otherwise, they might become contaminated as a result of soldering operations or deformed as a result of overheating.

1) For prototypes and short runs protect the connectors with an industrial adhesive tape, e.g. Tesaband 4331 (www.tesa.de). Cover the underside of the connector moulding and the adjacent parts of the pcb as well as the open sides of the connector. This will prevent heat and gases of the soldering apparatus from damaging the connector. About 140 + 5 mm of the tape should suffice.

2) For large series a jig is recommended. Its protective cover with a fast action mechanical locking devie shields the connectors from gas and heat generated by the soldering apparatus. As an additional protection a foil can be used for covering the parts that should not be soldered.

3) For prototypes and short runs the protection described under point 1) can be replaced by a solder protection cap. This cap can be ordered under the part no. 09 02 000 9935.

### Mating conditions



To ensure reliable connections and prevent unnecessary damage, please refer to the application data diagrams. These recommendations are set out in IEC 60603-2.

The connectors should not be coupled and decoupled under electrical load.

Page 4 / 4 | Creation date 2021-12-18 | Please note that the data specified here were taken as extracts from the online catalogue. Please refer to the user documentation for the complete and up-to-date information and data. Please also note that the user is responsible for validating functionality, conformity with applicable laws and directives, as well as for the electrical safety in the particular application.

HARTING Electronics GmbH | Marienwerderstraße 3 | 32339 Espelkamp | Germany

Phone +49 5772 47-97200 | electronics@HARTING.com | www.HARTING.com

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for High Speed/Modular Connectors category:

Click to view products by HARTING manufacturer:

Other Similar products are found below :

650827-1 74040-1346 1410191-1 1410337-1 1410368-3 1410367-3 1410971-4 1467833-1 2000877-1 200878-1 2041314-1 2065387-1 2187307-1 163P 1934290-1 2000875-1 2065799-1 2065917-1 2102736-2 FSR-40 2169868-2 22354-8 437-5040-000 039-0246-000 0740618502 0761601016 73774-1000 030-2415-003/100 PK 030-7380-004 030-2494-001 532939-1 5532901-3 3-1469268-7 UMK-SE 11,25-1 74748-102LF 10041743-101LF 10066670-100002LF 1-533915-1 249-4515-000 7-1469373-3 DL2-2J/S 2000713-8 2000713-7 10124313-101LF 1410189-2 3011-21 EBTF-4-10-2.0-S-RA-1 430305-001 4395800100 8140115